

Design of Microstrip Bandpass Coupled Lines Filter

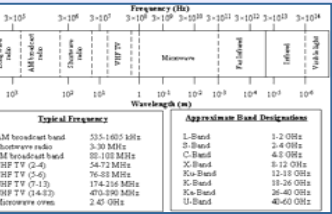
Teh Ghee Tean (Danny9811@yahoo.co.uk) and Prof. Madya Hj. Ayob B. Johari
Kolej Universiti Teknologi Tun Hussein Onn (KUiTTHO)

ABSTRACT

This project describes the design and fabrication of microwave bandpass filter by using microstrip layout. A microwave filter is a two port network used to control the frequency response within a system by allowing the transmission of certain frequencies in the passband while attenuating frequencies in the stopband. The development of the microstrip filters are simulated by using (MWO) Microwave Office 2003 (V6.01) simulator software. Photolithographic process is used for fabrication. The final testing had done by using the RF Network Analyzer.

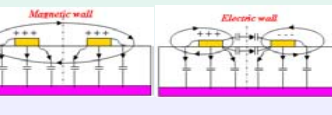
INTRODUCTION

The rapid growth in commercial microwave technology, varies of microwave communication system had been developed. Hence, Microstrip filters play important roles in many RF or microwave applications. Emerging applications such as wireless communications continue to challenge RF/microwave filters with ever more stringent requirements higher performance, smaller size, lighter weight, and lower cost.



COUPLED MICROSTRIP LINES

Coupled microstrip lines are exhibiting a field pattern with the quasi-TEM. A signal propagating in a coupled line can be described by the superposition of an even mode and odd mode which exhibit different propagation factors and characteristic impedance.



MICROSTRIP FILTER DESIGN STEP

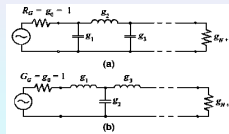
1. Determine the number of sections from the specified attenuation characteristics for microstrip parameters.

Frequency Range	Number of order	Equal Ripple Response	Impedance (Z_0)
1452 MHz to 1492 MHz	3	0.5 dB	50 Ω

2. Determine the values of the prototype elements to realize the specifications. Example Chebyshev filter prototypes ($g_0=1$, $w_c=1$ and 3.0 dB ripple)

3.0 dB Ripple			
n	g_n	g_n	g_n
1	1.8603	1.0000	1.0000
2	3.1013	0.5339	0.8399
3	3.3487	0.7157	3.3487

3. Determine the one-type resonator network (cascaded series resonators) and determine the inverter values for two equivalent realizations of the generic multi-section lowpass filter with normalized elements.



4. Obtain the even and odd mode coupled line characteristic impedances Z_{0e} and Z_{0o} .

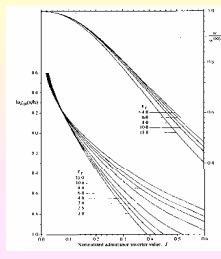
$$(Z_{0e})_{n+1} = Z_0 \left[1 + \frac{J_{n+1}^2}{Y_0} \left(\frac{J_{n+1}}{Y_0} \right)^2 \right]$$

$$(Z_{0o})_{n+1} = Z_0 \left[1 - \frac{J_{n+1}^2}{Y_0} \left(\frac{J_{n+1}}{Y_0} \right)^2 \right]$$

Where;

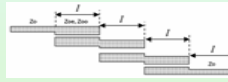
$$J_{n+1} = \frac{\pi \text{FBW}}{\sqrt{2g_n g_{n+1}}}, \quad \frac{J_{n+1}}{Y_0} = \frac{n\delta}{2 \sqrt{g_n g_{n+1}}}, \quad J_{n+1} = \frac{\pi \text{FBW}}{\sqrt{2g_{n+1} g_n}}$$

5. Determine microstrip widths and separations (W,s) of the parallel coupled resonant lines from the Quasi-Static synthesis graphs.



6. Calculate the coupled section length l_k which is slightly less than quarter wavelength at centre frequency to account for the end fringing.

$$\lambda_0 = \frac{300}{F \text{ (GHz)} \sqrt{\epsilon_{eff}}} \text{ mm}; \quad l_k = \frac{\lambda_0}{4}$$



(MWO) SIMULATION DESIGN

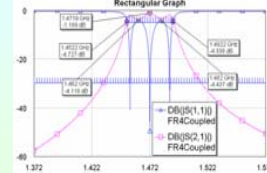
Symbols are used for circuit representation of the filter. Behind each symbol there is a model, the input parameters for the model are specified under each symbol. In this case the filter is composed of microstrip coupled lines (MSCL).

Once the filter is specified we can generate the layout from the circuit representation. We can then perform electromagnetic (EM) analysis over the layout and compare the results.

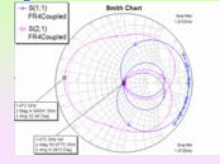


SIMULATION RESULT

Rectangular Graph showing S11 and S21 Parameters

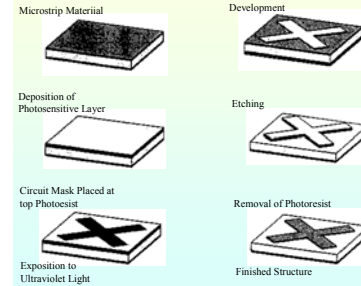


Smith Chart to define the Impedance Matching.



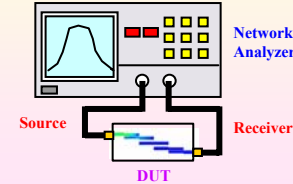
FABRICATION PROCESS

In the fabrication process, the circuit pattern is realized by the photolithographic process.



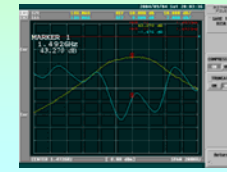
TESTING PROCESS

Network analyzer is used to measure the S-parameters (S11 Return Loss and S21 Insertion Loss) and impedance matching for the microwave filter.

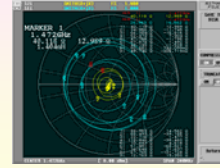


MEASUREMENT RESULT

The rectangular graph measurement for S11 (Return Loss) and S21 (Insertion Loss), the center frequency showed 1.492 GHz.



The Smith Chart measurement for impedance matching in frequency 1.472 GHz, $S_{11}=27.019$ ohm and $S_{21}=40.118$ ohm.



CONCLUSIONS

The result in between the simulation and physical layout design is difference. First, the dielectric constant of FR4 varies a lot from batch to batch. This means that the filter is likely to be too high or too low in frequency because the dielectric constant is out of our expectation. Secondly, FR4 material has high factor of loss tangent, hence it produced high losses for the design. Thirdly, the connection of the cables and connectors to the device also affect the result.

ACKNOWLEDGEMENTS

The author would like to express his sincere gratitude and appreciation to Prof. Ir. Dr. Ahmad Faizal bin Mohd. Zain for permitting the use of test equipment at the Wireless and Radio Science Centre (WARAS). The author is also grateful to Prof. Dr. Mohd. Zair bin Mohd. Jenu for use of testing apparatus at Electromagnetic Compatibility Centre (EMC) and Prof. Madya Hj. Ayob bin Johari for his supervision, guidance and advice as well as material support. Finally I would like to thank everyone for their full guidance and support while implementing this project.

REFERENCES

- [1] Ludwig, Reinhold and Bretchko, Pavel (2000). "RF Circuit Design - Theory and Application." New Jersey, USA: Prentice-Hall Inc.
- [2] Hong, Jia-Sheng and Lancaster, M.J. (2001). "Microstrip Filters for RF / Microwave Applications." USA: John Wiley & Sons, Inc.
- [3] Pozar, David M. (1998). "Microwave Engineering." 2nd Edition, USA: John Wiley & Sons, Inc.